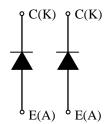
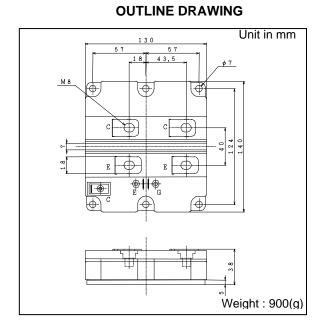
FEATURES

- * Low noise due to soft and fast recovery diodes.
- * High reliability, high durability diodes.
- * Isolated heat sink(terminal to base).

CIRCUIT DIAGRAM





ABSOLUTE MAXIMUM RATINGS (TC=25°C)

Item		Symbol	Unit	MDM600E45A
Repetitive Peak Reverse Voltage		V_{RRM}	V	4,500
Forward Current DC		l _F	Α	600
	1ms	I _{FM}		1,200
Junction Temperature		Tj	°C	-40 ∼ +125
Storage Temperature		Tstg	°C	-40 ∼ +125
Isolation Test Voltage	Terminals-base	V_{ISO}	\/	6,000 (AC 1 minute)
	Terminal 1-Terminal 2	V _{ISO T-T}	V_{RMS}	6,000 (AC 1 minute)
Screw Torque	Terminals (M8)	-	N⋅m	15 (1)
	Mounting (M6)	-	111.111	6 (2)

Notes: (1) Recommended Value 15⁺⁰/₋₃N·m

(2) Recommended Value 5.5±0.5N·m

ELECTRICAL CHARECTERISTICS

Item	Symbol	Unit	Min.	Тур.	Max.	Test Conditions
Repetitive Reverse Current	I_{RRM}	mΑ	-	14	27	VAK=4,500V, Tj=125°C
Forward Voltage Drop	V_{F}	V	3.3	4.5	5.3	IF=600A, Tj=125°C
Reverse Recovery Time	trr	μS	1	0.6	1.0	V _{CC} =2,600V, IF=600A, L=130nH
Reverse Recovery Loss	E _{rr(10%)}	J/P	•	0.7	1.0	Tj=125°C Rg=3.3 Ω (3)

PACKAGE CHARECTERISTICS

Item	Symbol	Unit	Min.	Тур.	Max.	Test Conditions
Terminal Resistance	RCE	$m\Omega$	-	0.3	-	
Terminal Stray Inductance	Lsce	nΗ	-	35	-	
Thermal Impedance	Rth(j-c)	K/W	-	-	0.026	Junction to case
Comparative tracking index	CTI		-	600	-	
Contact Thermal Impedance	Rth(c-f)	K/W	-	0.008	-	Case to fin per module

Notes:(3) Counter arm; MBN600E45A VGE=+/-15V

 R_{G} value is the test condition's value for evaluation of the switching times, not recommended value. Please, determine the suitable R_{G} value after the measurement of switching waveforms

(overshoot voltage, etc.) with appliance mounted.

* For improvement, specifications are subject to change without notice.



^{*} Please contact our representatives at order.

^{*} For actual application, please confirm this spec sheet is the newest revision.

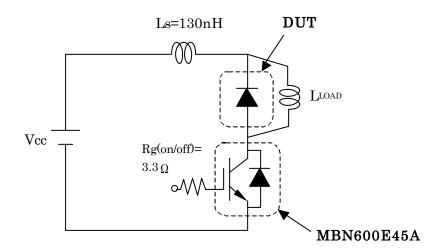


Fig.1 Switching test circuit

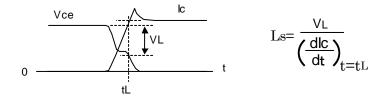


Fig.2 Definition of Ls

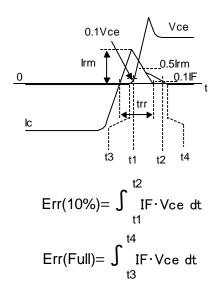
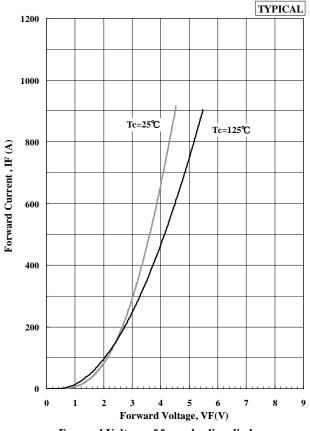
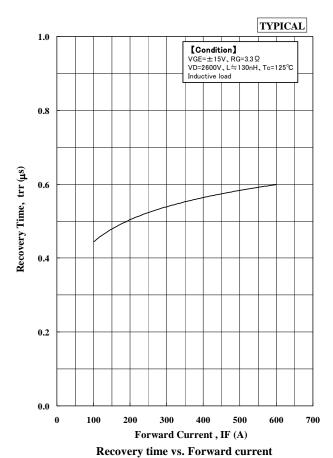


Fig.3 Definition of switching loss



Forward Voltage of free-wheeling diode



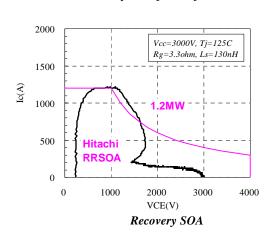
2.0

| Condition | VGE=±15V, RG=3.3 \(\text{Q} \) VD=2600V, \(\text{L}=130nH\), \(\text{Tc}=125\cappa \) | Inductive load | \(\text{L}=\text{130nH\}, \text{Tc}=125\cappa \) | \(\text{L}=\text{130nH\}, \text{Tc}=125\cappa \) | \(\text{L}=\text{L}=\text{130nH\}, \text{Tc}=125\cappa \) | \(\text{L}=\text

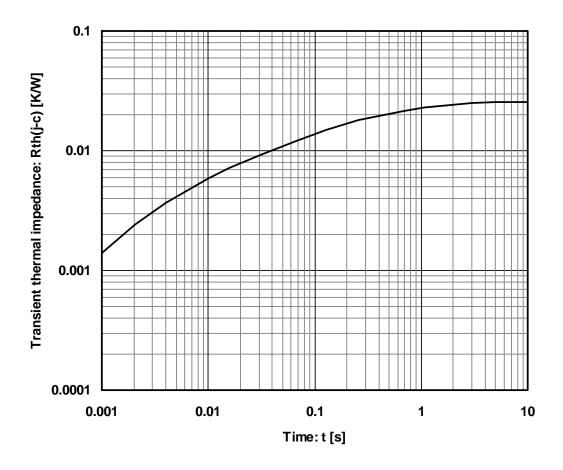
Vcc=3000V, Tj=125C
Rg=3.3ohm, Ls=130hH
IF:1000Adity
VCE:1000V/div
VCE:1000V/div

Time:lus/div

Recovery Waveform of Diode







Transient Thermal Impedance

Material declaration

Please note the following materials are contained in the product, in order to keep product characteristic and reliability level.

Material	Contained part
Lead (Pb) and its compounds	Solder



HITACHI POWER SEMICONDUCTORS

Notices

- The information given herein, including the specifications and dimensions, is subject to change without prior notice to improve product characteristics. Before ordering, purchasers are advised to contact Hitachi sales department for the latest version of this data sheets.
- 2. Please be sure to read "Precautions for Safe Use and Notices" in the individual brochure before use.
- 3. In cases where extremely high reliability is required (such as use in nuclear power control, aerospace and aviation, traffic equipment, life-support-related medical equipment, fuel control equipment and various kinds of safety equipment), safety should be ensured by using semiconductor devices that feature assured safety or by means of users' fail-safe precautions or other arrangement. Or consult Hitachi's sales department staff.
- 4. In no event shall Hitachi be liable for any damages that may result from an accident or any other cause during operation of the user's units according to this data sheets. Hitachi assumes no responsibility for any intellectual property claims or any other problems that may result from applications of information, products or circuits described in this data sheets.
- 5. In no event shall Hitachi be liable for any failure in a semiconductor device or any secondary damage resulting from use at a value exceeding the absolute maximum rating.
- 6. No license is granted by this data sheets under any patents or other rights of any third party or Hitachi Power Semiconductor Device, Ltd.
- 7. This data sheets may not be reproduced or duplicated, in any form, in whole or in part, without the expressed written permission of Hitachi Power Semiconductor Device, Ltd.
- 8. The products (technologies) described in this data sheets are not to be provided to any party whose purpose in their application will hinder maintenance of international peace and safety not are they to be applied to that purpose by their direct purchasers or any third party. When exporting these products (technologies), the necessary procedures are to be taken in accordance with related laws and regulations.
- For inquiries relating to the products, please contact nearest overseas representatives that is located "Inquiry" portion on the top page of a home page.

Hitachi power semiconductor home page address http://www.hitachi-power-semiconductor-device.co.jp/en/

